

# Package : VCSP85H2

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## 1. Structure and materials

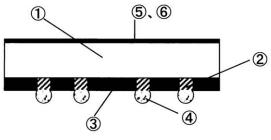


Fig. 1 Structure

| No. | Item          | Materials             |  |  |
|-----|---------------|-----------------------|--|--|
| 1   | Die           | Silicon               |  |  |
| 2   | Cu Post       | Cu                    |  |  |
| 3   | Encapsulation | Epoxy Resin           |  |  |
| 4   | Ext. terminal | Sn-3Ag-0.5Cu Solder   |  |  |
| 5   | Encapsulation | Polyamide-imide Resin |  |  |
| 6   | Marking       | Laser Marking         |  |  |

Dehydrated weight : 0.01g

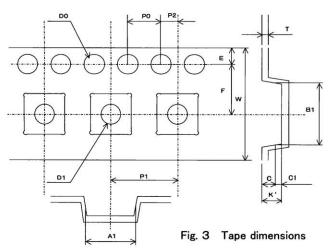
## 2. Tape and Reel information

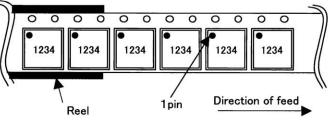
2. 1. Packing specification

| Таре              | Embossed carrier tape |  |
|-------------------|-----------------------|--|
| Quantity          | 2,500pcs/Reel         |  |
| Direction of feed | E2 (See Fig. 2)       |  |

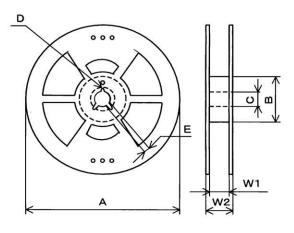
#### 2. 2. Tape and Reel specification

2. 2. 1. Tape and reel dimensions (See the table on page 2/4)











(Tape dimensions)

| A1   | B1   | С      | C1     | D0         | D1   | E    | F    | К'   | P0   | P1   | P2   | Т     | W    |
|------|------|--------|--------|------------|------|------|------|------|------|------|------|-------|------|
| 3.40 | 3.40 | (0.85) | (0.30) | Φ1.5       | Φ1.5 | 1.75 | 5.5  | 1.15 | 4.0  | 8.0  | 2.0  | 0.3   | 12.0 |
| ±0.1 | ±0.1 |        |        | +0.1<br>-0 | +0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.1 | ±0.05 | ±0.3 |

(Reel dimensions)

| Α    | в | С | D             | Е | W1 | W2 |
|------|---|---|---------------|---|----|----|
| Φ330 |   |   | Ф 20.2<br>MIN |   |    |    |

(Unit:mm)

- 2. 3. Leader and Trailer
- 2. 3. 1. Leader

No component pockets are 25 pockets or more.

2. 3. 2. Trailer

No component pockets are 10 pockets or more. Tape is free from reel.

2. 4. Label for Reel and Box

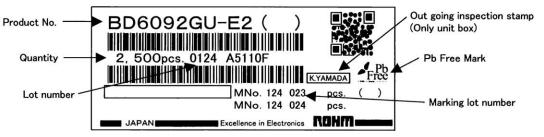
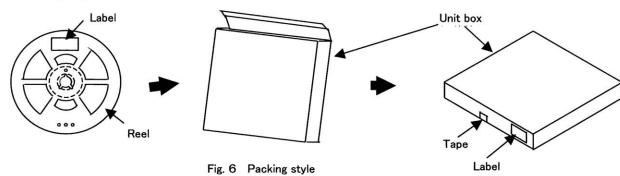


Fig. 5 Label example

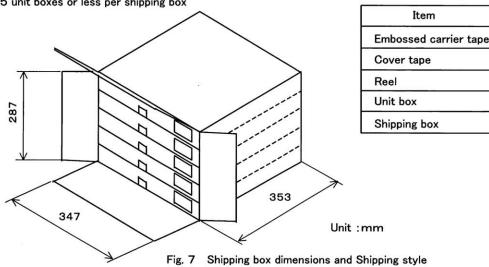
2. 5. Packing style



2. 7. Packing materials

Item

- 2. 6. Shipping style
  - 5 unit boxes or less per shipping box



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Material PS

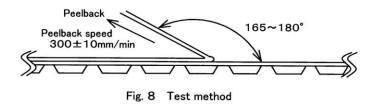
PET + PE PS

Cardboard

Cardboard

- 2.8. Others
- 2. 8. 1. Peelback strength

Cover tape peelback strength is  $0.2 \sim 0.7$  N.



2. 8. 2. Missing ICs

(1)No consecutive dropouts.

(2) A maximun 0.1% of specified number of products in each packing may be missing.

## 3. Storage conditions

3. 1. Storage environment

Recommended storage conditions are as follows :

-Temperature : 5~30°C

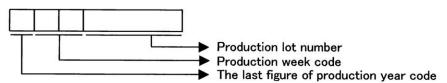
3. 2. Storage period

-Specified storage period : 1 year

3. 3. Specified storage period until soldering

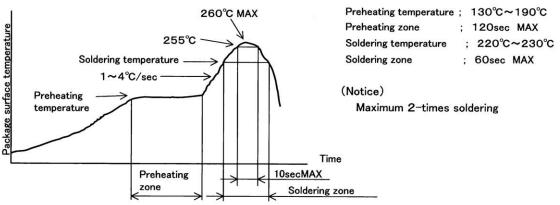
This package dose not require additional drying treatment as long as the moisture condition at the mounting process is within our recommended mounting condition.

## 4. Marking lot number



## 5. Soldering conditions

5. 1. Recommended temperature profile for reflow

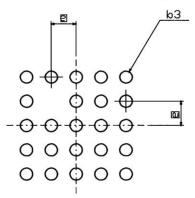


5. 2. About mounting with Sn-Pb solder paste.

Mounting with Sn-Pb solder paste is not recommended because it has a possibility of reducing reliability to connect with Sn-3.0Ag-0.5Cu solder balls.

- 5. 3. The wave soldering method is not supported.
- 5. 4. Partical heat supply method (by soldering iron) is not supported.

6. Footprint dimensions (Optimize footprint dimensions to the board design and soldering condition)

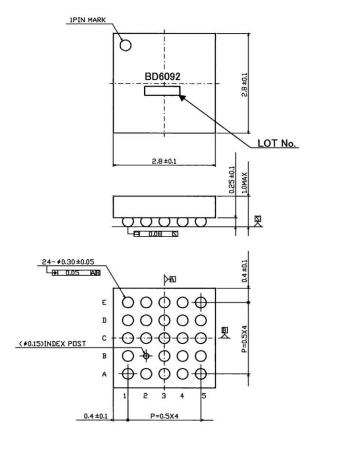


| Symbol | Reference<br>Value |
|--------|--------------------|
| е      | 0.50               |
| b3     | Φ0.25              |

## 7. External dimentions

(Unit:mm)

(Unit:mm)



#### 8. Precautions

8. 1. Caution for handling

Silicon substrate surface is exposing to the side of this package.

Therefore, please pay careful attention to chip and crack, and handle without touching the side of package.

8. 2. Regarding the underfill material

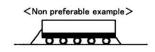
In some case, the underfill material is applied in order to reinforce the solder junction of package.

Since there is a case that solder joint reliability may deteriorate according to the resin material or coating condition, please evaluate it sufficiently for its application.

In term of the coating condition, it is preferable that there is an enough material beyond the each four sides of package.

<Preferable example>

(There is a Underfill resin evenly at each four sides.)



(There is little Underfill resin at one or two sides.)

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